



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

PCN Number:	20260818000.2	PCN Issued	August 18, 2026
Qualification of TI Melaka probe (TIEM-PR) as wafer Probe Test site for select devices		Sample request deadline:	N/A
		Estimated 1st ship date:	February 14, 2027

Change Type(s)	Test Process
ZVEI ID	SEM-QG-01

PCN Details

Description of Change:		
Texas Instruments is pleased to announce the qualification of TI Melaka probe (TIEM-PR) as a wafer probe test site for the devices listed below.		
	Current	Additional
Wafer Probe Test site	No probe	TIEM-PR (TI Melaka Probe)
Test coverage, insertions, conditions will remain consistent with current testing		
Reason for Change:	Improve test coverage and final test throughput Supply Continuity	

Anticipated impact on Form, Fit, Function, Quality or Reliability:	Request the Supporting Data Packet (SDP) for more details on the changes								
Impact on Environmental Ratings	Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings. <table><tr><td>RoHS</td><td>REACH</td><td>Green Status</td><td>IEC 62474</td></tr><tr><td>☒ No Change</td><td>☒ No Change</td><td>☒ No Change</td><td>☒ No Change</td></tr></table>	RoHS	REACH	Green Status	IEC 62474	☒ No Change	☒ No Change	☒ No Change	☒ No Change
RoHS	REACH	Green Status	IEC 62474						
☒ No Change	☒ No Change	☒ No Change	☒ No Change						
Changes to product identification resulting from this PCN:	None								

Products Affected:	
ISOW7741FQDFMRQ1	ISOW7742FQDFMRQ1
ISOW7741QDFMRQ1	ISOW7742QDFMRQ1

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

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